BORN SEMICONDUCTOR

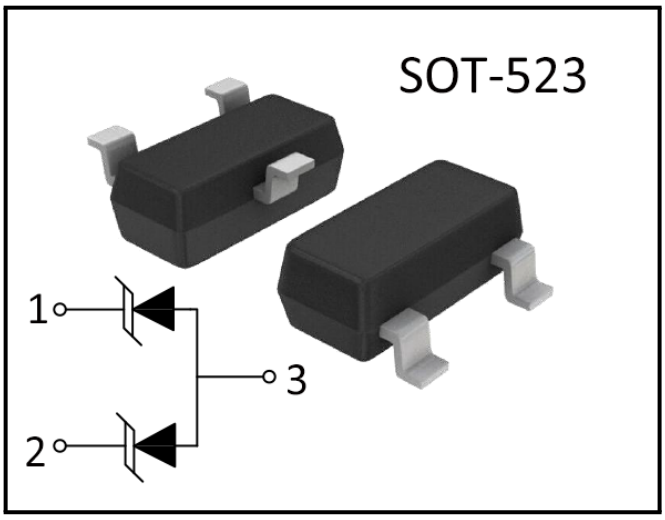
BST523A052U

ESD Protection Diode

Features

- 70Watts peak pulse power (tp = 8/20μs)
- Unidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping Voltage
- Low leakage current
- Low capacitance (Cj=0.5 pF typ.)
- Protection one data/power line
- IEC 61000-4-2 ±15kV contact ; ±20kV air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 4.0A (8/20μs)

Package



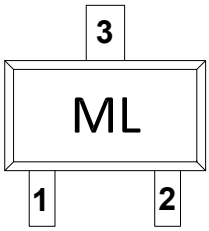
Applications

- Dataline
- Automatic Teller Machines
- Net works
- Power line

Mechanical Characteristics

- SOT-523 package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

Marking



Ordering information

Order code	Package	Base qty	Delivery mode
BST523A052U	SOT-523	3k	Tape and reel

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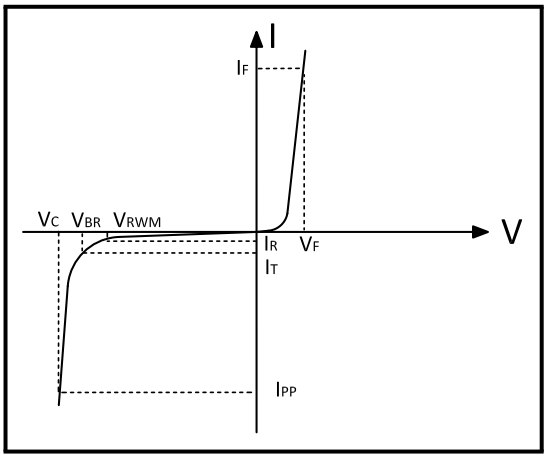
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ESD Protection Diode

Electrical Parameters (T_A = 25°C unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Peak Reverse Working Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current



Note:8/20us pulse Waveform.

Absolute Maximum Rating

Rating	Symber	Value	Units
Peak Pulse Power (tp =8/20μs)	P_{PP}	70	Watts
Peak Pulse Current (tp =8/20μs)	I_{PP}	4.0	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	20 15	KV
Lead Soldering Temperature	T_L	260(10seconds)	°C
Junction Temperature	T_J	-55 to + 150	°C
Storage Temperature	T_{stg}	-55 to + 150	°C

Electrical Characteristics

Parameter	Symber	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V_{RWM}	–	–	–	5.0	V
Reverse Breakdown Voltage	V_{BR}	I_T=1mA	6.0	7.0	9.5	V
Reverse Leakage Current	I_R	V_{RWM}=5V,T=25°C	–	–	0.2	uA
Peak Pulse Current	I_{PP}	tp =8/20us	–	–	4.0	A
Clamping Voltage	V_C	I_{PP}=4.0A, tp =8/20us	–	14	17	V
Junction Capacitance	C_j	V_R=0V,f=1MHZ	–	0.5	0.8	pF

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ESD Protection Diode

Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

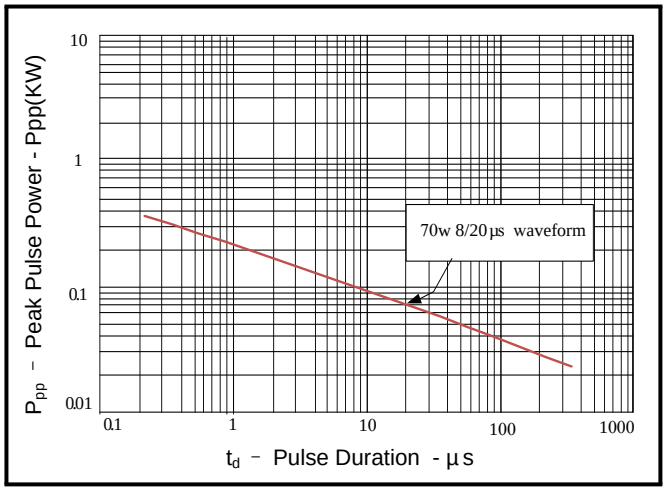


Figure 2: Power Derating Curve

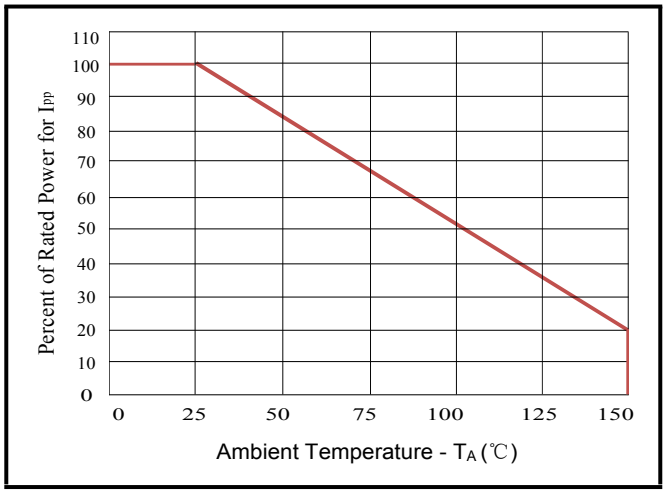


Figure 3: Pulse Waveform

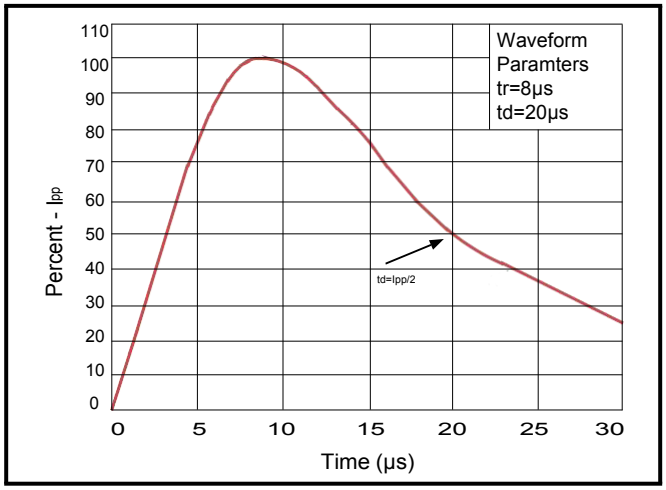
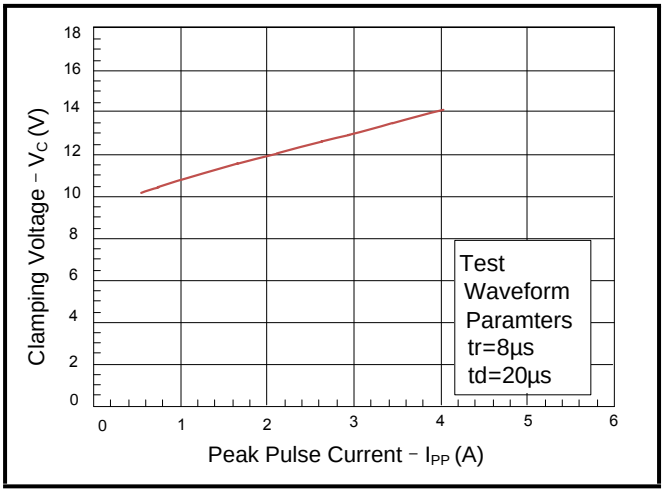


Figure 4: Clamping Voltage vs. I_{PP}



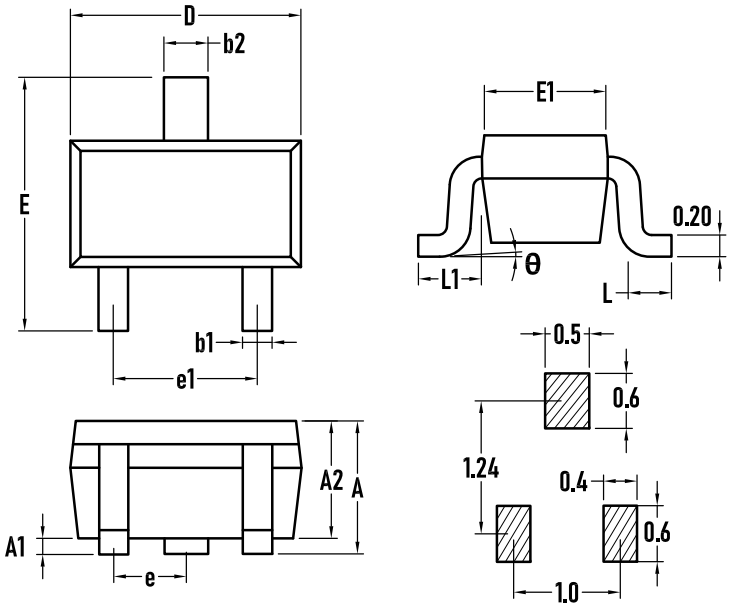
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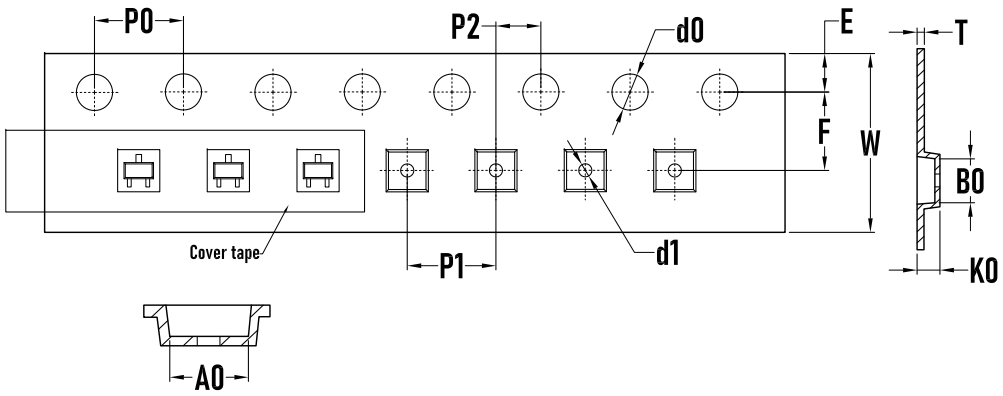
ESD Protection Diode

Outline Drawing – SOT-523



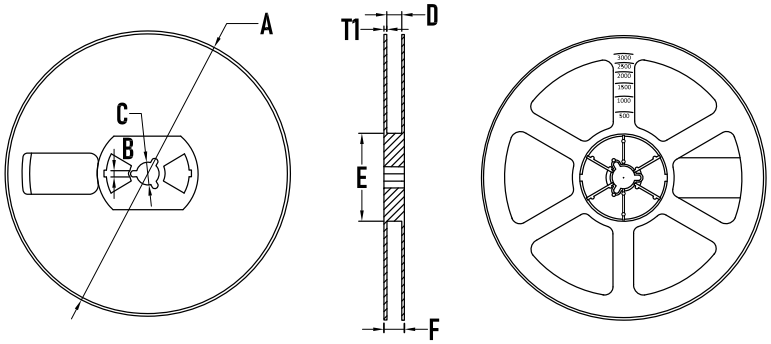
SYMBOL	MILLIMETER		
	MIN	TYP	MAX
A	0.70	0.80	0.90
A1	0.00	0.05	0.10
A2	0.70	0.75	0.80
b1	0.15	0.22	0.29
b2	0.25	0.32	0.39
D	1.50	1.60	1.70
E	1.45	1.60	1.75
E1	0.70	0.80	0.90
e	0.50(TPY.)		
e1	0.90	1.00	1.10
L	0.26	0.36	0.46
L1	0.40(REF)		
θ	0°	4°	8°

Packaging Tape - SOT-523



SYMBOL	MILLIMETER
A0	1.78±0.05
B0	1.78±0.05
d0	1.50+0.10
d1	0.50±0.10
E	1.75±0.10
F	3.50±0.05
K0	0.69±0.05
P0	4.00±0.10
P1	4.00±0.10
P2	2.00±0.10
W	8.00±0.20
T	0.20±0.02

Packaging Reel



SYMBOL	MILLIMETER
A	177.8±0.2
B	2.7±0.2
C	13.5±0.2
D	9.6±0.3
E	54.5±0.2
F	12.3±0.3
T1	1.0±0.2
Quantity	3000PCS

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